BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin





ATS Part#: ATS017017018-SF-5Q

Description: 17.00 x 17.00 x 18.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin
Heat Sink Attachment: superGRIP
Equivalent Part Number: N/A

*Image above is for illustration purpose only.

Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- Features a low profile, slant fin array that offers many of the performance benefits of maxiFLOW™ at a great value
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- · Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	8.18 °C/W	6.3 °C/W	5.4 °C/W	4.8 °C/W	4.4 °C/W	4.1 °C/W	3.9 °C/W
	Ducted Flow	5.2	4.4	4	3.6	3.4	3.2	3

Product Detail





